Disclosure No. 01-0509



## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN RE APPLICATION OF:

BOON SUAN JEUNG ET AL.

APPLICATION NO.:

10/033,340

FILED:

For:

**PATENT** 

Mai Huong C. TRAN **EXAMINER:** 

2818 ART UNIT:

7237 CONF. NO:

MULTISUBSTRATE MICROELECTRONIC
PACKAGES AND METHODS FOR
MANUFACTURE

Supplemental Information Disclosure Statement Within Three Months
of Application Filing or Before First Action – 37 C.F.R. § 1.97(b)

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

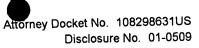
Sir:

Timing of Submission 1.

> This information disclosure is being filed within three months of the filing date of this application or date of entry into the national stage of an international application or before the mailing date of a first Office action on the merits, whichever occurs last [37 C.F.R. § 1.97(b)]. The references listed on the enclosed Form PTO-1449 (modified) may be material to the examination of this application; the Examiner is requested to make them of record in the application.

## Cited Information 2.

$\boxtimes$	Copies of the following references are enclosed:	
		All cited references References marked by asterisks The following:
	Copies of the following references can be found in parent U.S. Applicatio	
		All cited references References marked by asterisks The following:



	The following references are not in English. For each such reference, the undersigned has enclosed (i) a translation of the reference; (ii) a copy of a communication from a foreign patent office or International Searching Authority citing the reference, (iii) a copy of a reference which appears to be an English-language counterpart, or (iv) an English-language abstract for the reference prepared by a third party. Applicant has not verified that the translation, English-language counterpart or third-party abstract is an accurate representation of the teachings of the non-English reference, though, and reserves the right to demonstrate otherwise.		
	<ul><li>☐ All cited references</li><li>☐ References marked by ampersands</li><li>☐ The following:</li></ul>		
Effect of Information Disclosure Statement (37 C.F.R. § 1.97(h))			
that: exar resu cited app	Information Disclosure Statement is not to be construed as a representation (i) a search has been made; (ii) additional information material to the mination of this application does not exist; (iii) the information, protocols, alts and the like reported by third parties are accurate or enabling; or (iv) the dinformation is, or is considered to be, material to patentability. In addition, licant does not admit that any enclosed item of information constitutes prior to the subject invention and specifically reserves the right to demonstrate that such reference is not prior art.		
Fee Payment			
fee: the	fees are believed due. However, should the Commissioner determine that is are due in order for this Information Disclosure Statement to be considered, Commissioner is hereby authorized to charge such fees to Deposit Account 50-0665.		
Patent Term Adjustment (37 C.F.R. § 1.704(d))			
	The undersigned states that each item of information submitted herewith was cited in a communication from a foreign patent office in a counterpart application and that this communication was not received by any individual designated in 37 C.F.R. § 1.56(c) more than thirty days prior to the filing of this statement. 37 C.F.R. § 1.704(d).		

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4.

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Attorney Docket No. 108298631US Disclosure No. 01-0509

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Respectfully submitted,

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